

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[Alpha & Omega Semiconductor Inc.](#)
[AOB25S65L](#)

For any questions, you can email us directly:

sales@integrated-circuit.com



**ALPHA & OMEGA
SEMICONDUCTOR**

**AOT25S65/AOB25S65/AOTF25S65
650V 25A α MOS™ Power Transistor**

General Description

The AOT25S65 & AOB25S65 & AOTF25S65 have been fabricated using the advanced α MOS™ high voltage process that is designed to deliver high levels of performance and robustness in switching applications. By providing low $R_{DS(on)}$, Q_g and E_{oss} along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

For Halogen Free add "L" suffix to part number:
 AOT25S65L & AOB25S65 & AOTF25S65L

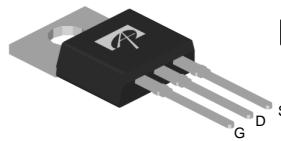
Product Summary

$V_{DS} @ T_{j,max}$	750V
I_{DM}	104A
$R_{DS(ON),max}$	0.19Ω
$Q_{g,typ}$	26.4nC
$E_{oss} @ 400V$	5.8μC

100% UIS Tested
 100% R_g Tested



TO-220



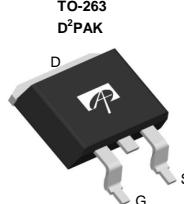
AOT25S65

TO-220F



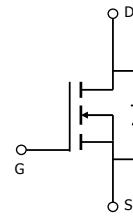
AOTF25S65

TO-263



AOB25S65

Top View



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOT25S65/AOB25S65	AOTF25S65	AOTF25S65L	Units
Drain-Source Voltage	V_{DS}		650		V
Gate-Source Voltage	V_{GS}		± 30		V
Continuous Drain Current	I_D <small>$T_c=25^\circ\text{C}$</small>	25	25*	25*	A
	I_D <small>$T_c=100^\circ\text{C}$</small>	16	16*	16*	
Pulsed Drain Current ^C	I_{DM}		104		
Avalanche Current ^C	I_{AR}		7		A
Repetitive avalanche energy ^C	E_{AR}		96		mJ
Single pulsed avalanche energy ^G	E_{AS}		750		mJ
Power Dissipation ^B	P_D <small>$T_c=25^\circ\text{C}$</small>	357	50	40	W
	P_D <small>Derate above 25°C</small>	2.9	0.4	0.3	
MOSFET dv/dt ruggedness	dv/dt		100		V/ns
Peak diode recovery dv/dt ^H			20		
Junction and Storage Temperature Range	T_J, T_{STG}		-55 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds ^J	T_L		300		°C

Thermal Characteristics

Parameter	Symbol	AOT25S65/AOB25S65	AOTF25S65	AOTF25S65L	Units
Maximum Junction-to-Ambient ^{A,D}	R_{qJA}	65	65	65	°C/W
Maximum Case-to-sink ^A	R_{qCS}	0.5	--	--	°C/W
Maximum Junction-to-Case	R_{qJC}	0.35	2.5	3.1	°C/W

* Drain current limited by maximum junction temperature.



AOT25S65/AOB25S65/AOTF25S65

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}, T_J=25^\circ\text{C}$	650	-	-	V
		$I_D=250\mu\text{A}, V_{GS}=0\text{V}, T_J=150^\circ\text{C}$	700	750	-	
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=650\text{V}, V_{GS}=0\text{V}$	-	-	1	μA
		$V_{DS}=520\text{V}, T_J=150^\circ\text{C}$	-	10	-	
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$	-	-	± 100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=5\text{V}, I_D=250\mu\text{A}$	2.6	3.3	4	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=12.5\text{A}, T_J=25^\circ\text{C}$	-	0.165	0.19	Ω
		$V_{GS}=10\text{V}, I_D=12.5\text{A}, T_J=150^\circ\text{C}$	-	0.47	0.53	Ω
V_{SD}	Diode Forward Voltage	$I_S=12.5\text{A}, V_{GS}=0\text{V}, T_J=25^\circ\text{C}$	-	0.84	-	V
I_S	Maximum Body-Diode Continuous Current		-	-	25	A
I_{SM}	Maximum Body-Diode Pulsed Current		-	-	104	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=100\text{V}, f=1\text{MHz}$	-	1278	-	pF
C_{oss}	Output Capacitance		-	87	-	pF
$C_{o(er)}$	Effective output capacitance, energy related ^H	$V_{GS}=0\text{V}, V_{DS}=0 \text{ to } 480\text{V}, f=1\text{MHz}$	-	64.5	-	pF
$C_{o(tr)}$	Effective output capacitance, time related ^I		-	236.7	-	pF
C_{rss}	Reverse Transfer Capacitance	$V_{GS}=0\text{V}, V_{DS}=100\text{V}, f=1\text{MHz}$	-	1.4	-	pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	-	4.9	-	Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=480\text{V}, I_D=12.5\text{A}$	-	26.4	-	nC
Q_{gs}	Gate Source Charge		-	6.2	-	nC
Q_{gd}	Gate Drain Charge		-	9.5	-	nC
$t_{D(on)}$	Turn-On DelayTime	$V_{GS}=10\text{V}, V_{DS}=400\text{V}, I_D=12.5\text{A}, R_G=25\Omega$	-	29	-	ns
t_r	Turn-On Rise Time		-	30	-	ns
$t_{D(off)}$	Turn-Off DelayTime		-	112	-	ns
t_f	Turn-Off Fall Time		-	34	-	ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=12.5\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=400\text{V}$	-	408	-	ns
I_{rm}	Peak Reverse Recovery Current	$I_F=12.5\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=400\text{V}$	-	33	-	A
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=12.5\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=400\text{V}$	-	8.27	-	μC

A. The value of R_{JJA} is measured with the device in a still air environment with $T_A=25^\circ\text{C}$.

B. The power dissipation P_D is based on $T_{J(\text{MAX})}=150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$, Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.

D. The R_{JJA} is the sum of the thermal impedance from junction to case R_{JJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using $<300\ \mu\text{s}$ pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(\text{MAX})}=150^\circ\text{C}$. The SOA curve provides a single pulse rating.

G. $L=60\text{mH}, I_{AS}=5\text{A}, V_{DD}=150\text{V}$, Starting $T_J=25^\circ\text{C}$

H. $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.

I. $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.

J. Wavesoldering only allowed at leads.

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.



AOT25S65/AOB25S65/AOTF25S65

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

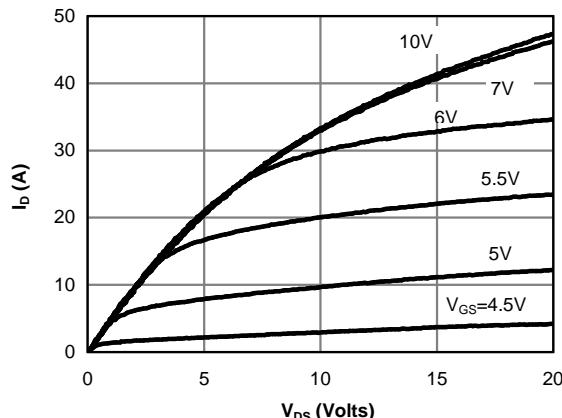


Figure 1: On-Region Characteristics @ 25°C

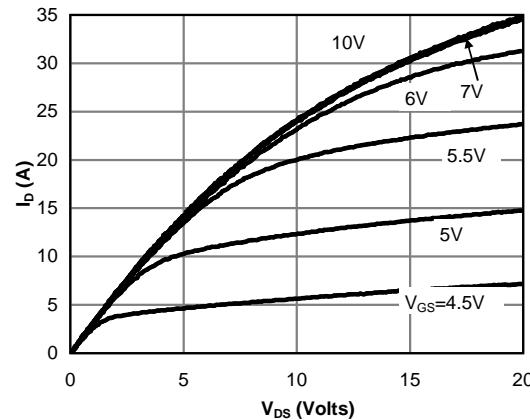


Figure 2: On-Region Characteristics @ 125°C

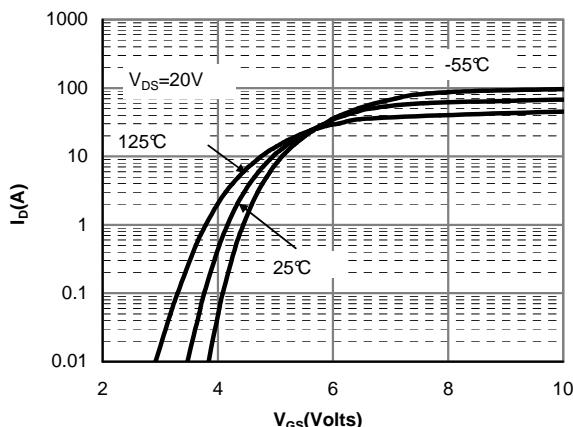


Figure 3: Transfer Characteristics

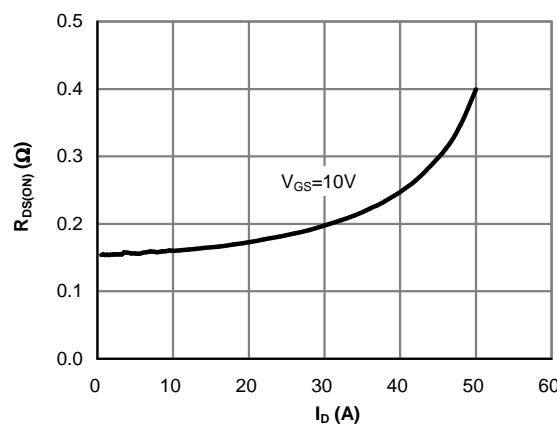


Figure 4: On-Resistance vs. Drain Current and Gate Voltage

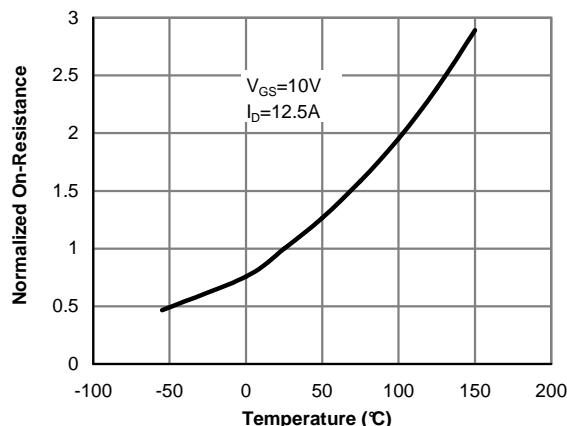


Figure 5: On-Resistance vs. Junction Temperature

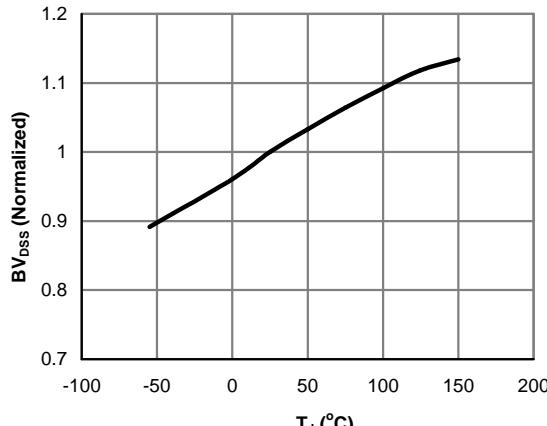


Figure 6: Break Down vs. Junction Temperature



AOT25S65/AOB25S65/AOTF25S65

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

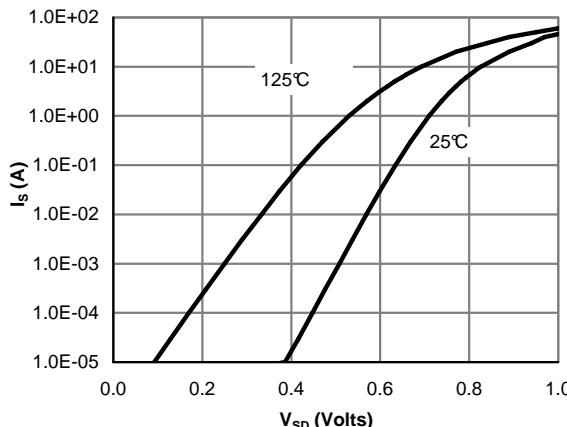


Figure 7: Body-Diode Characteristics (Note E)

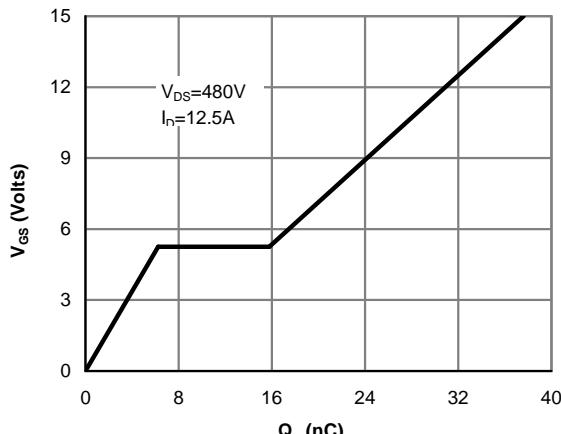


Figure 8: Gate-Charge Characteristics

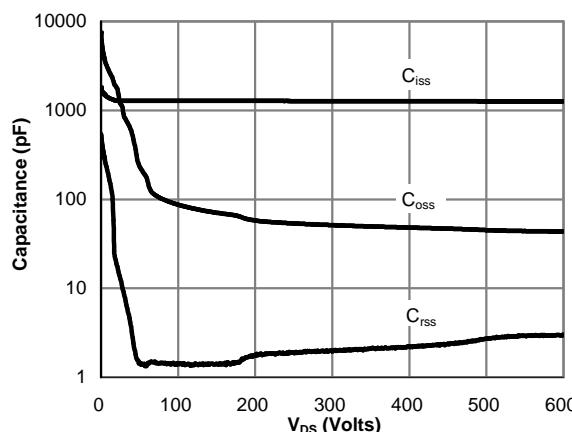


Figure 9: Capacitance Characteristics

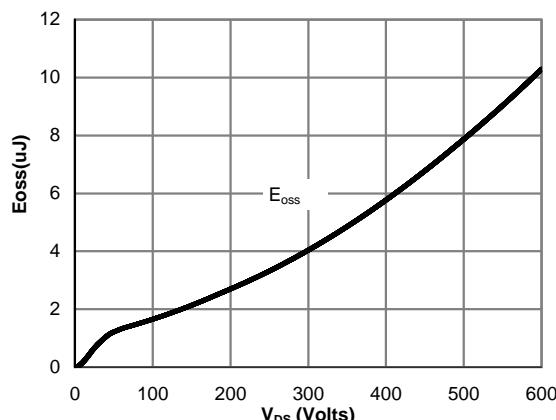


Figure 10: Coss stored Energy

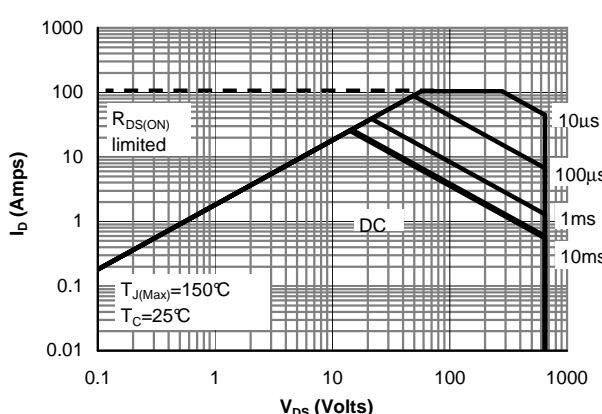


Figure 11: Maximum Forward Biased Safe Operating Area for AOT(B)25S65 (Note F)

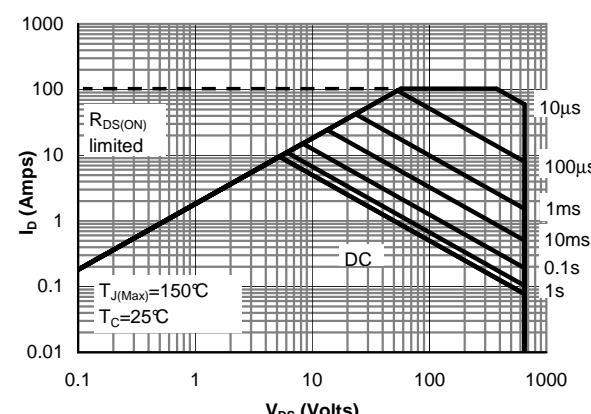


Figure 12: Maximum Forward Biased Safe Operating Area for AOTF25S65 (Note F)



AOT25S65/AOB25S65/AOTF25S65

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

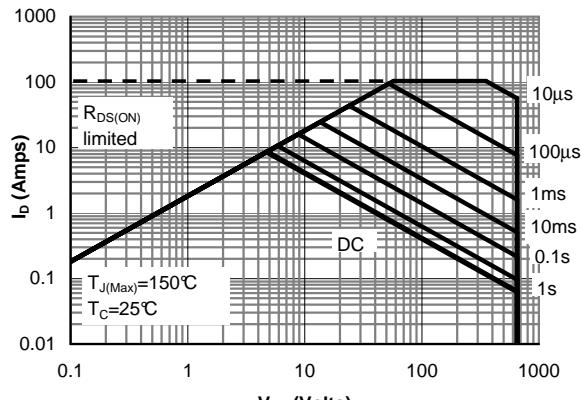


Figure 13: Maximum Forward Biased Safe Operating Area for AOTF25S65L (Note F)

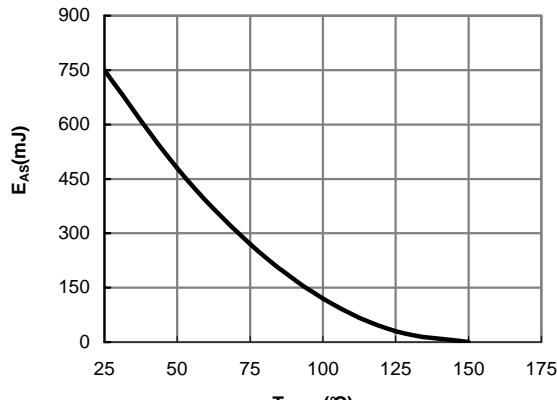


Figure 14: Avalanche energy

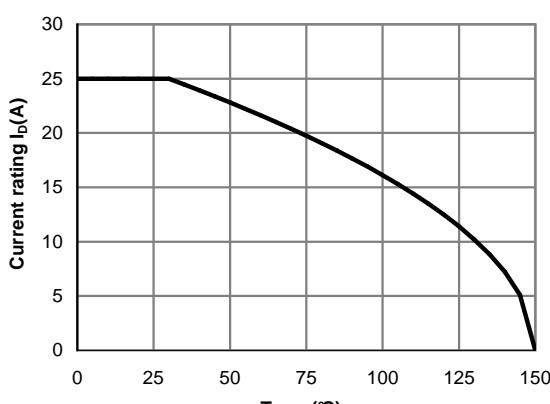


Figure 15: Current De-rating (Note B)



AOT25S65/AOB25S65/AOTF25S65

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

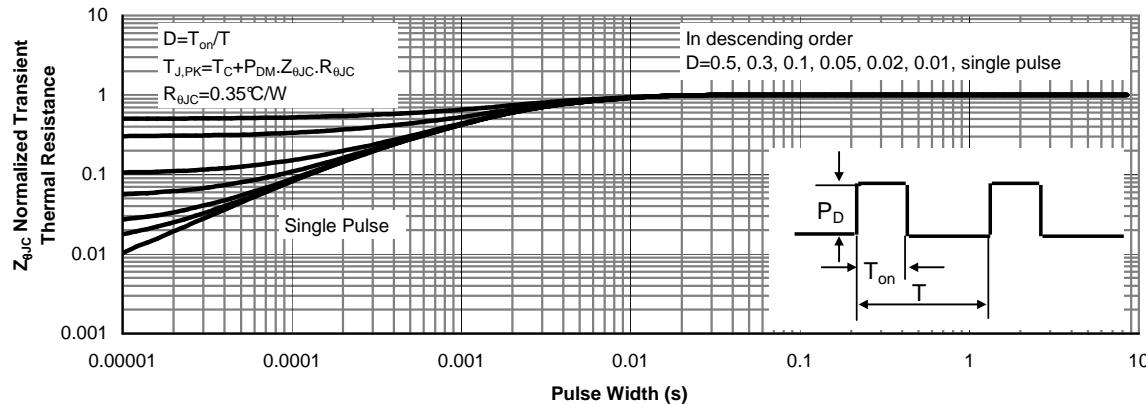


Figure 16: Normalized Maximum Transient Thermal Impedance for AOT(B)25S65 (Note F)

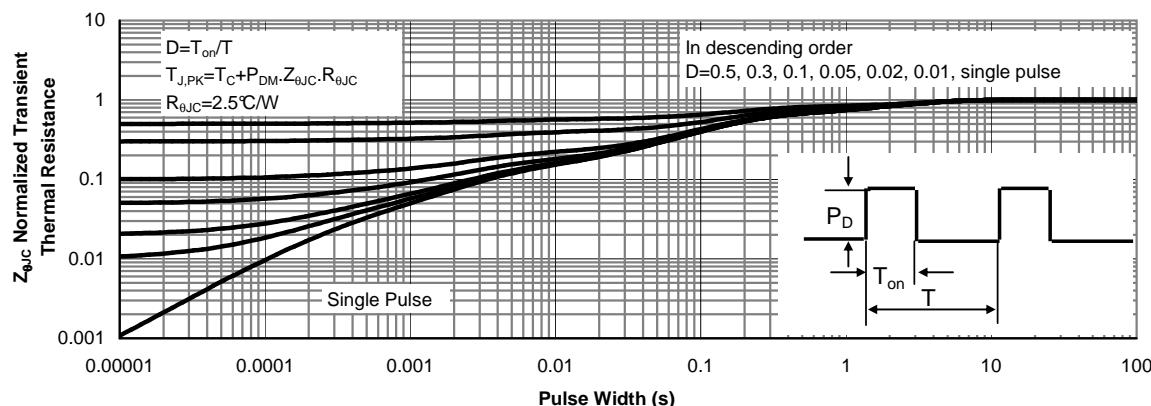


Figure 17: Normalized Maximum Transient Thermal Impedance for AOTF25S65 (Note F)

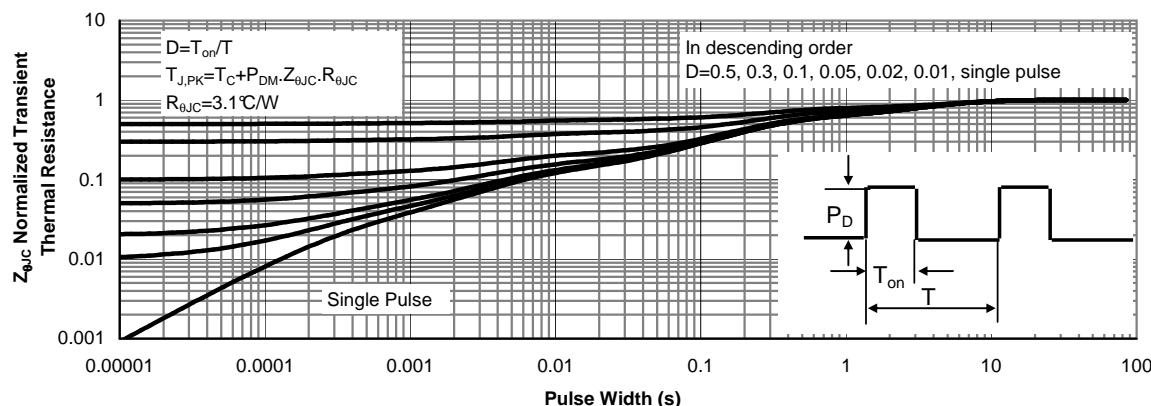


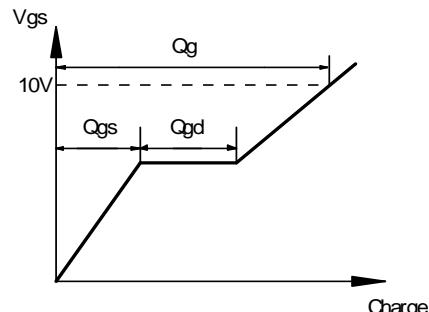
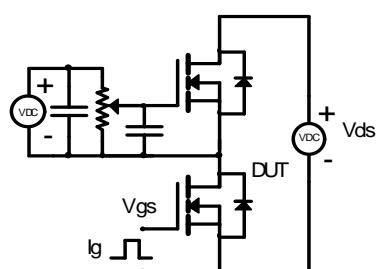
Figure 18: Normalized Maximum Transient Thermal Impedance for AOTF25S65L (Note F)



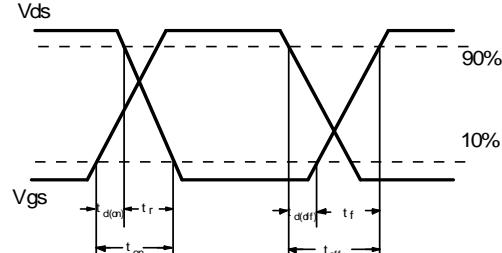
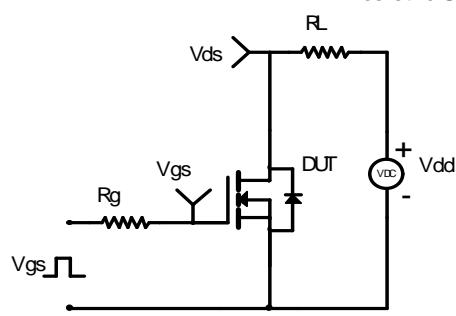
AOT25S65/AOB25S65/AOTF25S65



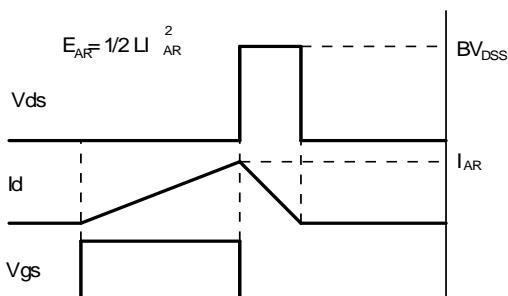
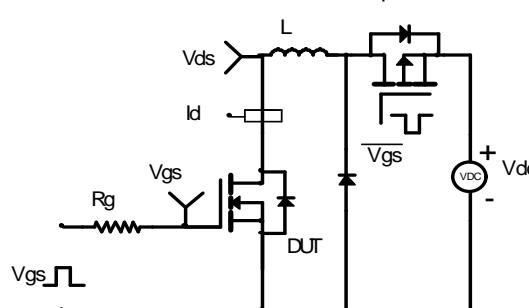
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

